




Features

- High power ratings
- Compliant with AEC-Q200 Rev-C- Stress Test Qualification for Passive Components in Automotive Applications
- Low profile
- Compatible with Pb and Pb-free solder reflow profiles
- RoHS compliant* and halogen free**
- Surface mount packaging for automated assembly
- Agency recognition: 
- Standard 7555 mm (2920 mils) footprint

MF-LSMF Series - PTC Resettable Fuses

Electrical Characteristics

Model***	V max. Volts	I max. Amps	I _{hold}		I _{trip}		Resistance		Max. Time To Trip		Tripped Power Dissipation
			Amperes at 23 °C		Ohms at 23 °C		Amperes at 23 °C	Seconds at 23 °C	Watts at 23 °C		
			Hold	Trip	R _{Min.}	R _{1Max.}				Typ.	
MF-LSMF185/33X	33.0	40	1.85	3.70	0.045	0.150	8.0	2.50	1.5		
MF-LSMF260X	24.0	20	2.60	5.20	0.020	0.075	8.0	5.00	1.5		
MF-LSMF300X	6.0	40	3.00	5.00	0.015	0.048	8.0	20.00	1.5		
MF-LSMF300/24X	24.0	20	3.00	5.20	0.020	0.075	8.0	5.00	1.5		

*** Features Multifuse® Free Xpansion Design™ for MF-LSMF Series.

Environmental Characteristics

Operating Temperature.....	-40 °C to +85 °C
Maximum Device Surface Temperature in Tripped State	125 °C
Passive Aging	+85 °C, 1000 hours..... ±5 % typical resistance change
Humidity Aging	+85 °C, 85 % R.H. 1000 hours..... ±5 % typical resistance change
Thermal Shock	+85 °C to -40 °C, 20 times
Solvent Resistance.....	MIL-STD-202, Method 215..... No change
Vibration	MIL-STD-883C, Method 2007.1,
	Condition A

Test Procedures And Requirements For Model MF-LSMF Series

Test	Test Conditions	Accept/Reject Criteria
Visual/Mech.....	Verify dimensions and materials.....	Per MF physical description
Resistance.....	In still air @ 23 °C.....	R _{min} ≤ R ≤ R _{1max}
Time to Trip.....	At specified current, V _{max} , 23 °C	T ≤ max. time to trip (seconds)
Hold Current	30 min. at I _{hold}	No trip
Trip Cycle Life.....	V _{max} , I _{max} , 100 cycles.....	No arcing or burning
Trip Endurance	V _{max} , 48 hours.....	No arcing or burning
Solderability.....	ANSI/J-STD-002.....	95 % min. coverage

UL File Number E174545
<http://www.ul.com/> Follow link to Certifications, then UL File No., enter E174545

*RoHS Directive 2002/95/EC Jan 27, 2003 including Annex.

**Bourns is using the definition that appears to be the prevalent definition used as the industry standard at this time. The Bourns definition of "halogen-free" is: Bromine (Br) content: ≤ 900 ppm; Chlorine (Cl) content: ≤ 900 ppm; Total Br + Cl content: ≤ 1500 ppm.

Specifications are subject to change without notice.

Customers should verify actual device performance in their specific applications.

Applications

- Automotive electronics
- Industrial controls
- IEEE ports
- Portable electronics

MF-LSMF Series - PTC Resettable Fuses

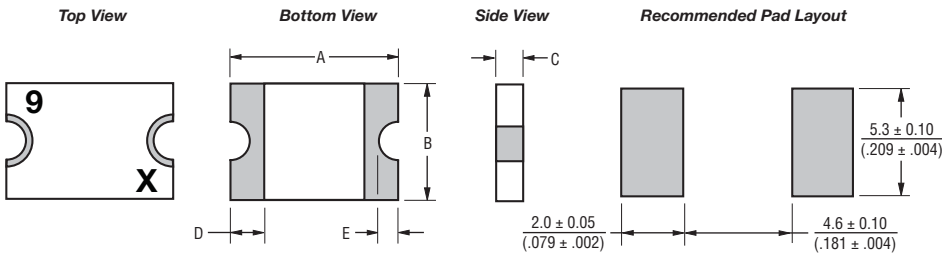
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Product Dimensions

Model	A		B		C		D	E	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	Max.
MF-LSMF185/33X	$\frac{6.73}{(0.265)}$	$\frac{7.98}{(0.312)}$	$\frac{4.80}{(0.189)}$	$\frac{5.44}{(0.214)}$	$\frac{0.75}{(0.030)}$	$\frac{1.60}{(0.063)}$	$\frac{0.30}{(0.012)}$	$\frac{0.25}{(0.010)}$	$\frac{2.00}{(0.079)}$
MF-LSMF260X	$\frac{6.73}{(0.265)}$	$\frac{7.98}{(0.312)}$	$\frac{4.80}{(0.189)}$	$\frac{5.44}{(0.214)}$	$\frac{0.75}{(0.030)}$	$\frac{1.60}{(0.063)}$	$\frac{0.30}{(0.012)}$	$\frac{0.25}{(0.010)}$	$\frac{2.00}{(0.079)}$
MF-LSMF300X	$\frac{6.73}{(0.265)}$	$\frac{7.98}{(0.312)}$	$\frac{4.80}{(0.189)}$	$\frac{5.44}{(0.214)}$	$\frac{0.35}{(0.014)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	$\frac{0.25}{(0.010)}$	$\frac{2.00}{(0.079)}$
MF-LSMF300/24X	$\frac{6.73}{(0.265)}$	$\frac{7.98}{(0.312)}$	$\frac{4.80}{(0.189)}$	$\frac{5.44}{(0.214)}$	$\frac{0.75}{(0.030)}$	$\frac{1.60}{(0.063)}$	$\frac{0.30}{(0.012)}$	$\frac{0.25}{(0.010)}$	$\frac{2.00}{(0.079)}$

Packaging: 3000 pcs. per reel.

DIMENSIONS: $\frac{\text{MM}}{\text{(INCHES)}}$



Terminal material:

Electroless Ni under immersion Au

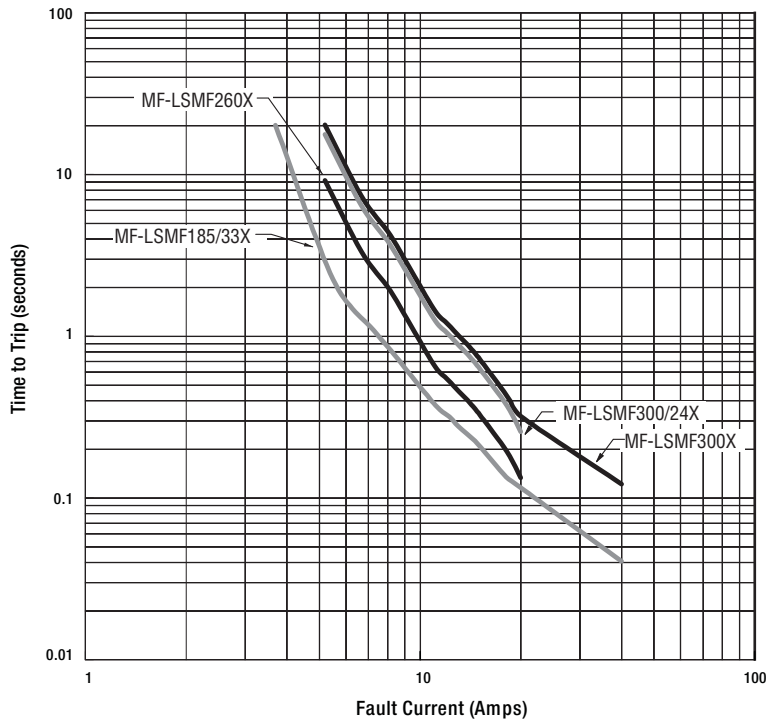
Termination pad solderability:

Standard Au finish:
Meets ANSI/J-STD-002 Category 2.

Recommended Storage:

40 °C max./70 % RH max.

Typical Time to Trip at 23 °C



The Time to Trip curves represent typical performance of a device in a simulated application environment. Actual performance in specific customer applications may differ from these values due to the influence of other variables.

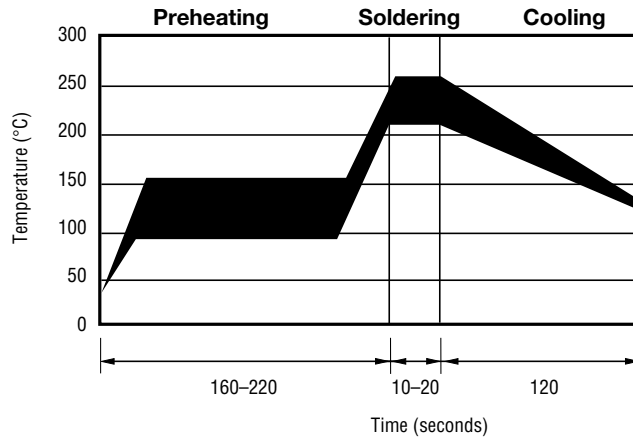
MF-LSMF Series - PTC Resettable Fuses

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Thermal Derating Chart - I_{hold} (Amps)

Model	Ambient Operating Temperature								
	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C
MF-LSMF185/33X	2.80	2.47	2.17	1.85	1.54	1.39	1.22	1.07	0.85
MF-LSMF260X	3.75	3.35	3.00	2.60	2.35	2.15	2.05	1.80	1.30
MF-LSMF300X	4.53	4.02	3.51	3.00	2.52	2.26	1.99	1.75	1.34
MF-LSMF300/24X	4.00	3.55	3.20	3.00	2.50	2.25	2.15	1.85	1.50

Solder Reflow Recommendations



Notes:

- MF-LSMF models cannot be wave soldered. Please contact Bourns for hand soldering recommendations.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Compatible with Pb and Pb-free solder reflow profiles.

How to Order

MF - LSMF 185/33X - 2

Multifuse® Product Designator _____
 Series _____
 LSMF = 7555 mm (2920 mils)
 Surface Mount Component
 Hold Current, I_{hold} _____
 185-300 (1.85 Amps - 3.00 Amps)
 Higher Voltage Option _____
 /24 = 24 Volt Rated
 /33 = 33 Volt Rated
 X = Multifuse® freeXpansion™ Design
 MF-LSMF Series
 Packaging _____
 Packaged per EIA 481-1
 -2 = Tape and Reel

Typical Part Marking

Represents total content. Layout may vary.

PART IDENTIFICATION EXAMPLES:
 MF-LSMF185/33X = 9
 MF-LSMF260X = E
 MF-LSMF300X = F
 MF-LSMF300/24X = J

E - BI-WEEKLY DATE CODE:
 WEEKS 47-48 = X

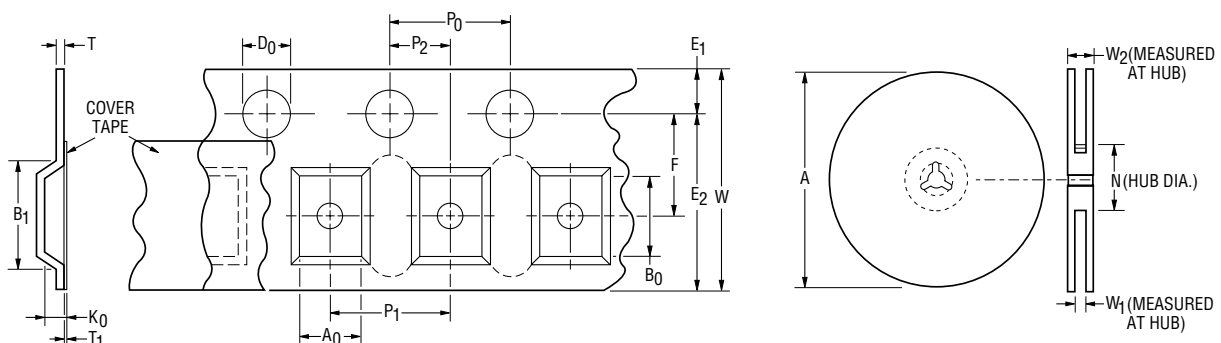
MF-LSMF Series Tape and Reel Specifications

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NOTE: Effective December 1, 2010 (product date code "X"), the cover tape will be changed to the new 3M™ Universal Cover Tape (UCT).

Tape Dimensions	MF-LSMF300X	MF-LSMF185/33X, MF-LSMF260X,
	per EIA 481-2	MF-LSMF300/24X per EIA 481-2
W	16.0 ± 0.30 (0.630 ± 0.012)	16.0 ± 0.30 (0.630 ± 0.012)
P ₀	4.0 ± 0.10 (0.157 ± 0.004)	4.0 ± 0.10 (0.157 ± 0.004)
P ₁	8.0 ± 0.10 (0.315 ± 0.004)	8.0 ± 0.10 (0.315 ± 0.004)
P ₂	2.0 ± 0.05 (0.079 ± 0.002)	2.0 ± 0.05 (0.079 ± 0.002)
A ₀	5.74 ± 0.10 (0.226 ± 0.004)	5.70 ± 0.10 (0.224 ± 0.004)
B ₀	8.02 ± 0.10 (0.316 ± 0.004)	8.10 ± 0.10 (0.319 ± 0.004)
B ₁ max.	12.1 (0.476)	12.1 (0.476)
D ₀	1.5 + 0.10/-0.0 (0.059 + 0.004/-0)	1.5 + 0.10/-0.0 (0.059 + 0.004/-0)
F	7.5 ± 0.05 (0.295 ± 0.002)	7.5 ± 0.05 (0.295 ± 0.002)
E ₁	1.75 ± 0.10 (0.069 ± 0.004)	1.75 ± 0.10 (0.069 ± 0.004)
E ₂ min.	14.25 (0.561)	14.25 (0.561)
T max.	0.6 (0.024)	0.6 (0.024)
T ₁ max.	0.1 (0.004)	0.1 (0.004)
K ₀	0.91 ± 0.10 (0.036 ± 0.004)	1.70 ± 0.10 (0.067 ± 0.004)
Leader min.	390 (15.35)	390 (15.35)
Trailer min.	160 (6.30)	160 (6.30)
Reel Dimensions		
A max.	331 (13.03)	331 (13.03)
N min.	50 (1.97)	50 (1.97)
W ₁	16.4 + 2.0/-0.0 (0.646 + 0.079/-0.0)	16.4 + 2.0/-0.0 (0.646 + 0.079/-0.0)
W ₂ max.	22.4 (0.882)	22.4 (0.882)

DIMENSIONS: $\frac{\text{MM}}{\text{(INCHES)}}$



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<http://moschip.ru/get-element>

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